

|                     |              |
|---------------------|--------------|
| $V_{DSS}$           | 650V         |
| $R_{DS(on)}$ (Typ.) | 22m $\Omega$ |
| $I_D^{*1}$          | 93A          |
| $P_D$               | 339W         |

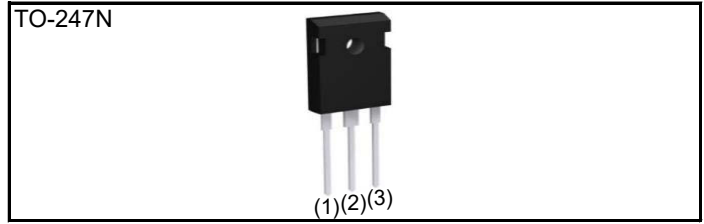
#### ●Features

- 1) Qualified to AEC-Q101
- 2) Low on-resistance
- 3) Fast switching speed
- 4) Fast reverse recovery
- 5) Easy to parallel
- 6) Simple to drive
- 7) Pb-free lead plating ; RoHS compliant

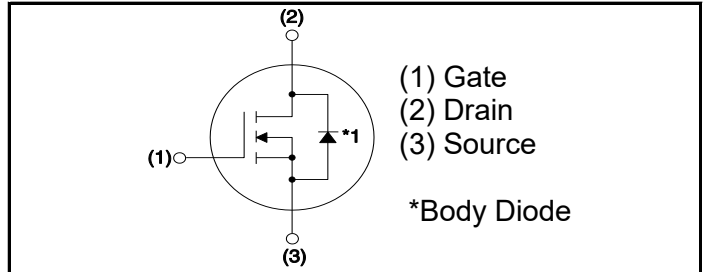
#### ●Application

- Automobile
- Switch mode power supplies

#### ●Outline



#### ●Inner circuit



#### ●Packaging specifications

| Type | Packing                   | Tube      |
|------|---------------------------|-----------|
|      | Reel size (mm)            | -         |
|      | Tape width (mm)           | -         |
|      | Basic ordering unit (pcs) | 30        |
|      | Taping code               | C11       |
|      | Marking                   | SCT3022AL |

#### ●Absolute maximum ratings ( $T_a = 25^\circ\text{C}$ )

| Parameter  | Symbol                    | Value       | Unit             |
|--|---------------------------|-------------|------------------|
| Drain - Source Voltage                                     | $V_{DSS}$                 | 650         | V                |
| Continuous Drain current                                   | $T_c = 25^\circ\text{C}$  | $I_D^{*1}$  | 93 A             |
|  | $T_c = 100^\circ\text{C}$ | $I_D^{*1}$  | 65 A             |
| Pulsed Drain current                                       | $I_{D,pulse}^{*2}$        | 232         | A                |
| Gate - Source voltage (DC)                                 | $V_{GSS}$                 | -4 to +22   | V                |
| Gate - Source surge voltage ( $t_{surge} < 300\text{ns}$ ) | $V_{GSS,surge}^{*3}$      | -4 to +26   | V                |
| Recommended drive voltage                                  | $V_{GS,op}^{*4}$          | 0 / +18     | V                |
| Junction temperature                                       | $T_j$                     | 175         | $^\circ\text{C}$ |
| Range of storage temperature                               | $T_{stg}$                 | -55 to +175 | $^\circ\text{C}$ |

**●Electrical characteristics** ( $T_a = 25^\circ\text{C}$ )

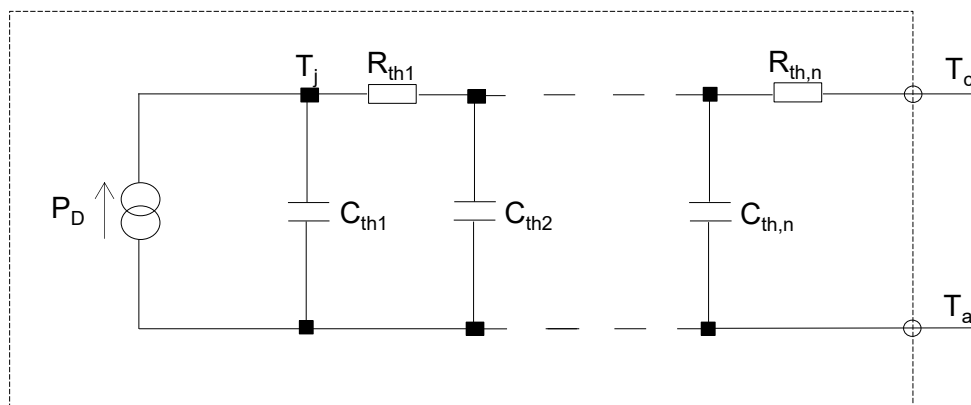
| Parameter                                   | Symbol            | Conditions  | Values     |          |           | Unit          |
|---|-------------------|---|------------|----------|-----------|---------------|
|   |                   |   | Min.       | Typ.     | Max.      |               |
| Drain - Source breakdown voltage            | $V_{(BR)DSS}$     | $V_{GS} = 0\text{V}, I_D = 1\text{mA}$<br>$T_j = 25^\circ\text{C}$<br>$T_j = -55^\circ\text{C}$     | 650<br>650 | -<br>-   | -<br>-    | V             |
| Zero Gate voltage Drain current             | $I_{DSS}$         | $V_{GS} = 0\text{V}, V_{DS} = 650\text{V}$<br>$T_j = 25^\circ\text{C}$<br>$T_j = 150^\circ\text{C}$ | -<br>-     | 1<br>2   | 10<br>-   | $\mu\text{A}$ |
| Gate - Source leakage current               | $I_{GSS+}$        | $V_{GS} = +22\text{V}, V_{DS} = 0\text{V}$  | -          | -        | 100       | nA            |
| Gate - Source leakage current               | $I_{GSS-}$        | $V_{GS} = -4\text{V}, V_{DS} = 0\text{V}$   | -          | -        | -100      | nA            |
| Gate threshold voltage                      | $V_{GS(th)}$      | $V_{DS} = 10\text{V}, I_D = 18.2\text{mA}$  | 2.7        | -        | 5.6       | V             |
| Static Drain - Source on - state resistance | $R_{DS(on)}^{*5}$ | $V_{GS} = 18\text{V}, I_D = 36\text{A}$<br>$T_j = 25^\circ\text{C}$<br>$T_j = 150^\circ\text{C}$    | -<br>-     | 22<br>32 | 28.6<br>- | m $\Omega$    |
| Gate input resistance                       | $R_G$             | $f = 1\text{MHz}, \text{open drain}$  | -          | 5        | -         | $\Omega$      |

**●Thermal resistance**

| Parameter                           | Symbol     | Values |      |      | Unit               |
|-------------------------------------|------------|--------|------|------|--------------------|
|                                     |            | Min.   | Typ. | Max. |                    |
| Thermal resistance, junction - case | $R_{thJC}$ | -      | 0.34 | 0.44 | $^\circ\text{C/W}$ |

**●Typical Transient Thermal Characteristics**

| Symbol    | Value    | Unit | Symbol    | Value    | Unit |
|-----------|----------|------|-----------|----------|------|
| $R_{th1}$ | 4.83E-03 | K/W  | $C_{th1}$ | 1.40E-03 | Ws/K |
| $R_{th2}$ | 1.73E-01 |      | $C_{th2}$ | 1.13E-02 |      |
| $R_{th3}$ | 1.63E-01 |      | $C_{th3}$ | 6.02E-02 |      |



●Electrical characteristics (T<sub>a</sub> = 25°C)

| Parameter                                    | Symbol            | Conditions  | Values |      |      | Unit    |
|--|-------------------|---|--------|------|------|---------|
|  |                   |   | Min.   | Typ. | Max. |         |
| Transconductance                             | $g_{fs}^{*5}$     | $V_{DS} = 10V, I_D = 36A$   | -      | 12.2 | -    | S       |
| Input capacitance                            | $C_{iss}$         | $V_{GS} = 0V$   | -      | 2208 | -    | pF      |
| Output capacitance                           | $C_{oss}$         | $V_{DS} = 500V$   | -      | 118  | -    |         |
| Reverse transfer capacitance                 | $C_{rss}$         | $f = 1MHz$  | -      | 52   | -    |         |
| Effective output capacitance, energy related | $C_{o(er)}$       | $V_{GS} = 0V$<br>$V_{DS} = 0V \text{ to } 300V$   | -      | 303  | -    | pF      |
| Total Gate charge                            | $Q_g^{*5}$        | $V_{DS} = 300V$<br>$I_D = 36A$  | -      | 133  | -    | nC      |
| Gate - Source charge                         | $Q_{gs}^{*5}$     | $V_{GS} = 18V$  | -      | 22   | -    |         |
| Gate - Drain charge                          | $Q_{gd}^{*5}$     | See Fig. 1-1.   | -      | 69   | -    |         |
| Turn - on delay time                         | $t_{d(on)}^{*5}$  | $V_{DS} = 300V$<br>$I_D = 18A$  | -      | 25   | -    | ns      |
| Rise time                                    | $t_r^{*5}$        | $V_{GS} = 0V/+18V$  | -      | 53   | -    |         |
| Turn - off delay time                        | $t_{d(off)}^{*5}$ | $R_G = 0\Omega$<br>$R_L = 17\Omega$   | -      | 61   | -    |         |
| Fall time                                    | $t_f^{*5}$        | See Fig. 1-1, 1-2.  | -      | 35   | -    |         |
| Turn - on switching loss                     | $E_{on}^{*5}$     | $V_{DS} = 300V$<br>$V_{GS}=0V/18V, I_D = 36A$<br>$R_G = 0\Omega, L = 100\mu H$                        | -      | 252  | -    | $\mu J$ |
| Turn - off switching loss                    | $E_{off}^{*5}$    | $E_{on}$ includes diode reverse recovery<br>$L_\sigma = 50nH, C_\sigma = 200pF$<br>See Fig. 2-1, 2-2. | -      | 201  | -    |         |

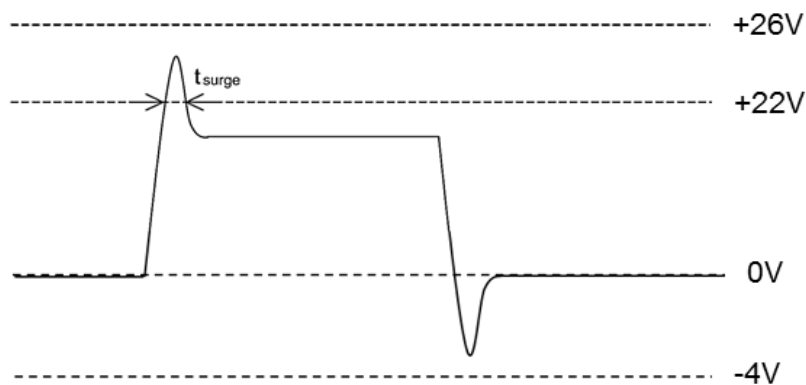
**●Body diode electrical characteristics (Source-Drain) ( $T_a = 25^\circ\text{C}$ )**

| Parameter                              | Symbol       | Conditions  | Values  |      |      | Unit |
|--|--------------|---|---|------|------|------|
|  |              |   | Min.  | Typ. | Max. |      |
| Body diode continuous, forward current | $I_S$ *1     | $T_c = 25^\circ\text{C}$  | -   | -    | 93   | A    |
| Body diode direct current, pulsed      | $I_{SM}$ *2  |   | -   | -    | 232  | A    |
| Forward voltage                        | $V_{SD}$ *5  | $V_{GS} = 0\text{V}, I_D = 36\text{A}$  | -   | 3.2  | -    | V    |
| Reverse recovery time                  | $t_{rr}$ *5  | $I_F = 36\text{A}$<br>$V_R = 300\text{V}$<br>$di/dt = 1100\text{A}/\mu\text{s}$ | -   | 27   | -    | ns   |
| Reverse recovery charge                | $Q_{rr}$ *5  |   | -   | 146  | -    | nC   |
| Peak reverse recovery current          | $I_{rrm}$ *5 |   | $L_\sigma = 50\text{nH}, C_\sigma = 200\text{pF}$<br>See Fig. 3-1, 3-2. | -    | 10   | -    |

\*1 Limited by maximum temperature allowed.

\*2  $P_W \leq 10\mu\text{s}$ , Duty cycle  $\leq 1\%$

\*3 Example of acceptable  $V_{GS}$  waveform



\*4 Please be advised not to use SiC-MOSFETs with  $V_{GS}$  below 13V as doing so may cause thermal runaway.

\*5 Pulsed

●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

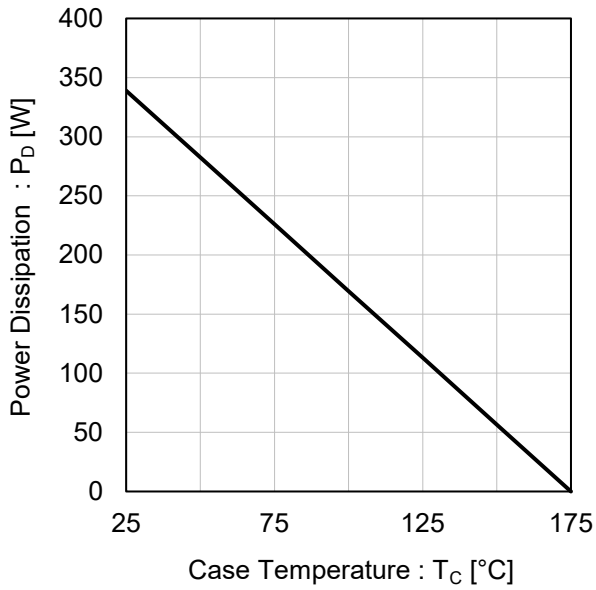


Fig.2 Maximum Safe Operating Area

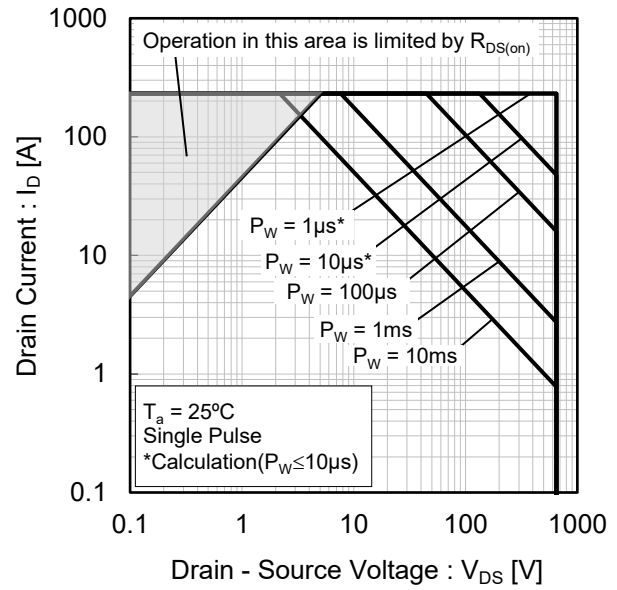
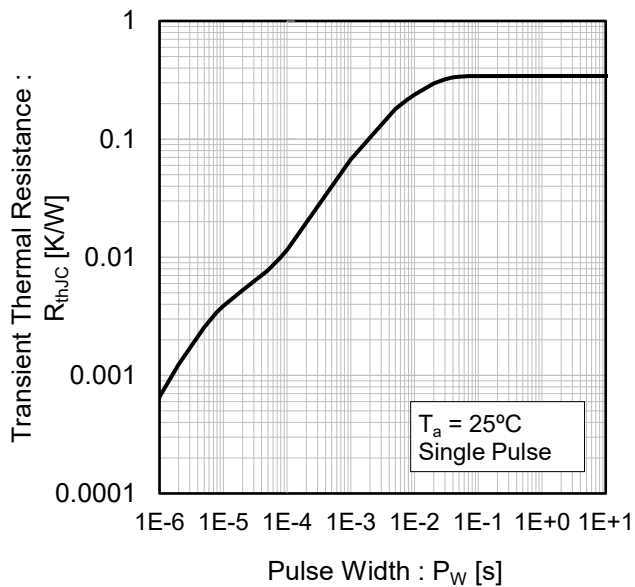


Fig.3 Typical Transient Thermal Resistance vs. Pulse Width



●Electrical characteristic curves

Fig.4 Typical Output Characteristics(I)

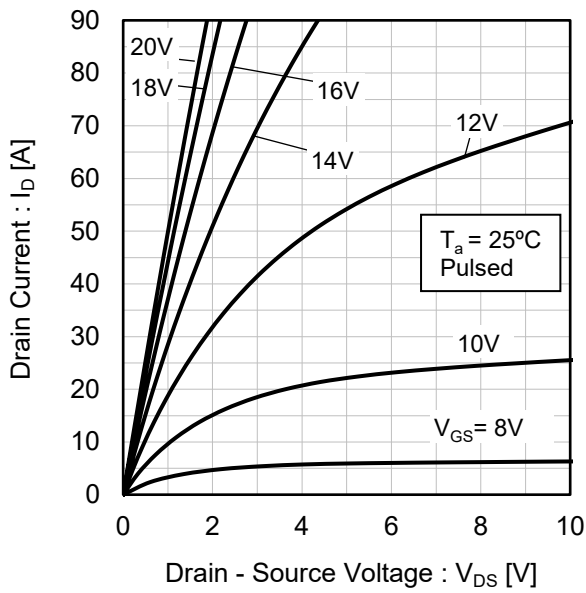


Fig.5 Typical Output Characteristics(II)

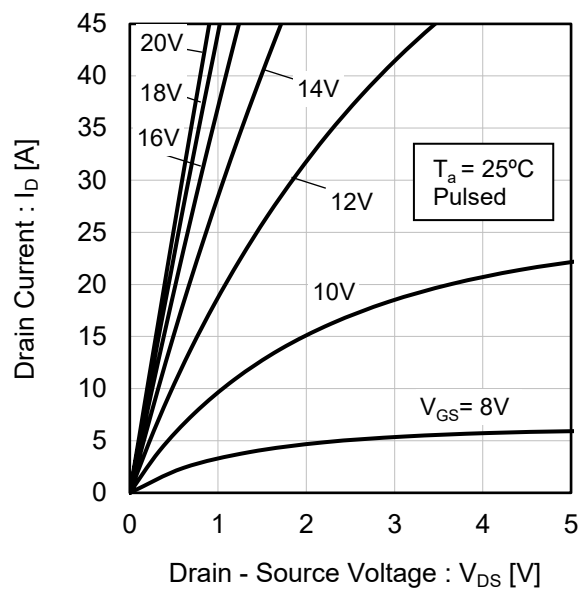
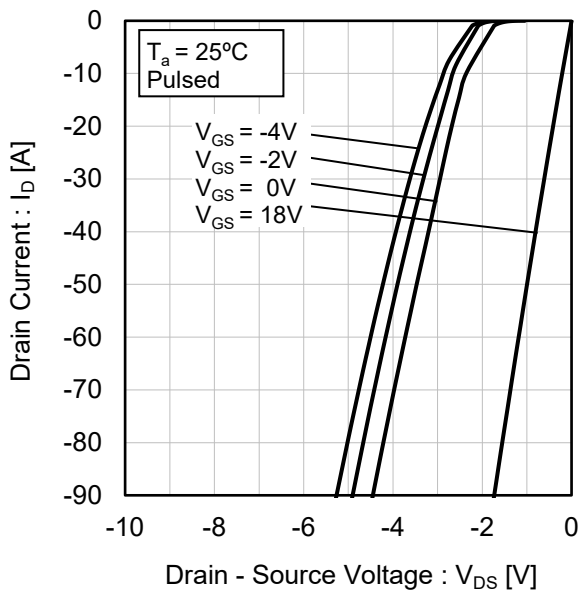


Fig.6  $T_j = 25^\circ\text{C}$  3rd Quadrant Characteristics



●Electrical characteristic curves

Fig.7  $T_j = 150^\circ\text{C}$  Typical Output Characteristics(I)

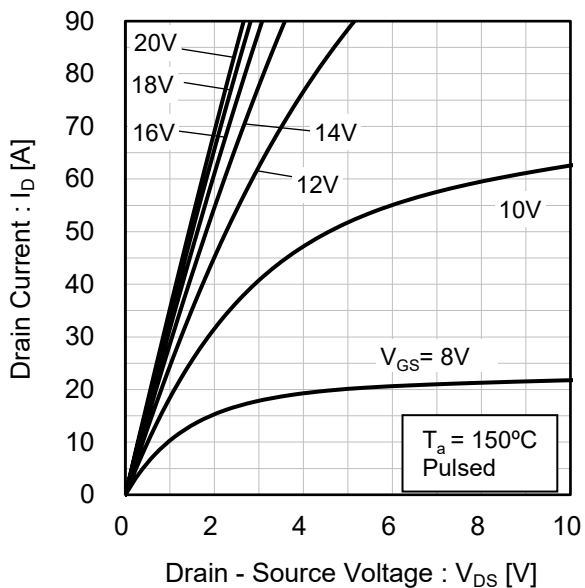


Fig.8  $T_j = 150^\circ\text{C}$  Typical Output Characteristics(II)

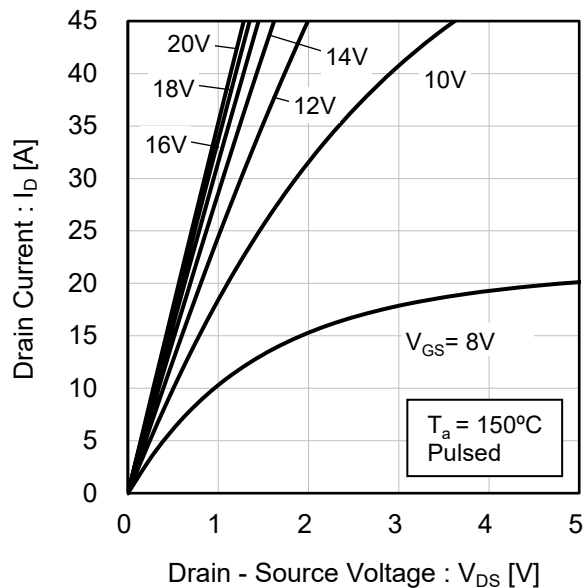


Fig.9  $T_j = 150^\circ\text{C}$  3rd Quadrant Characteristics

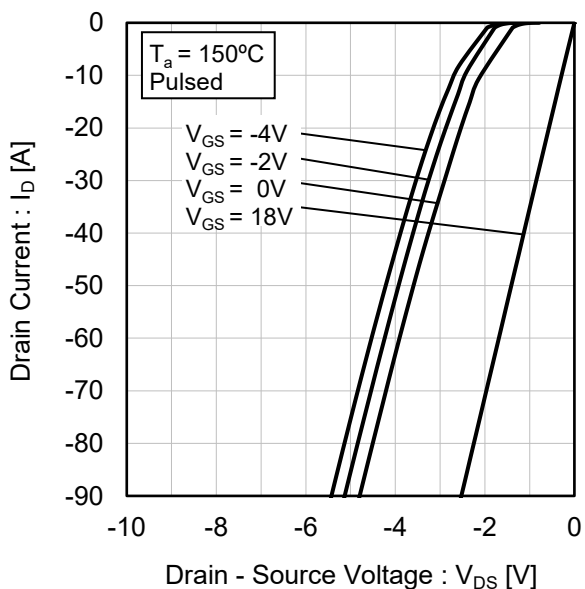
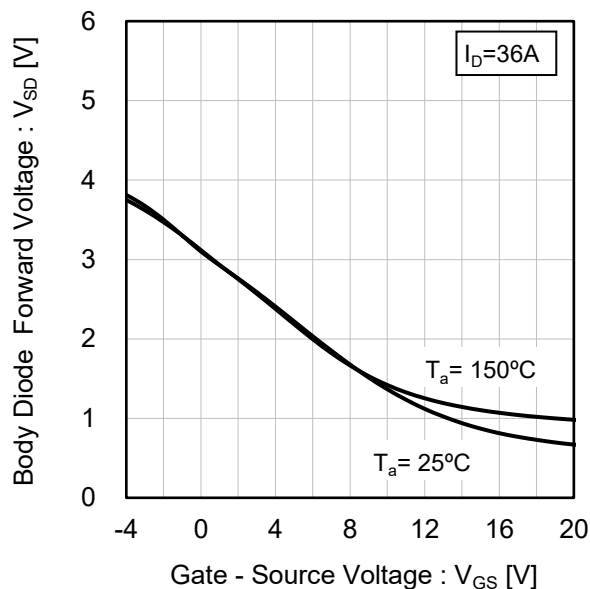


Fig.10 Body Diode Forward Voltage vs. Gate - Source Voltage



●Electrical characteristic curves

Fig.11 Typical Transfer Characteristics (I)

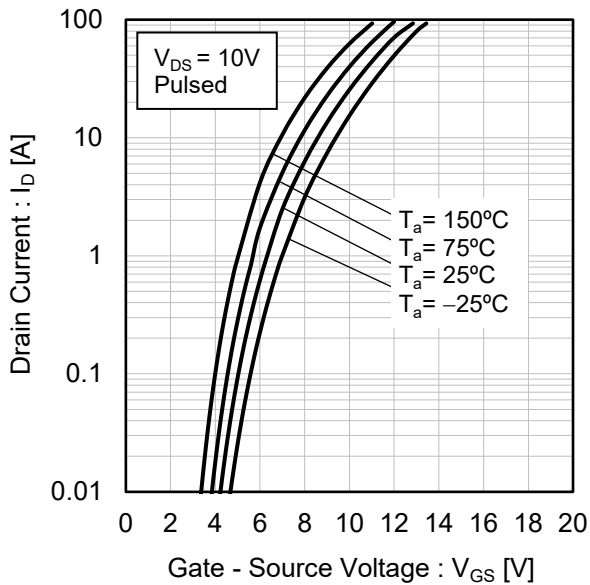


Fig.12 Typical Transfer Characteristics (II)

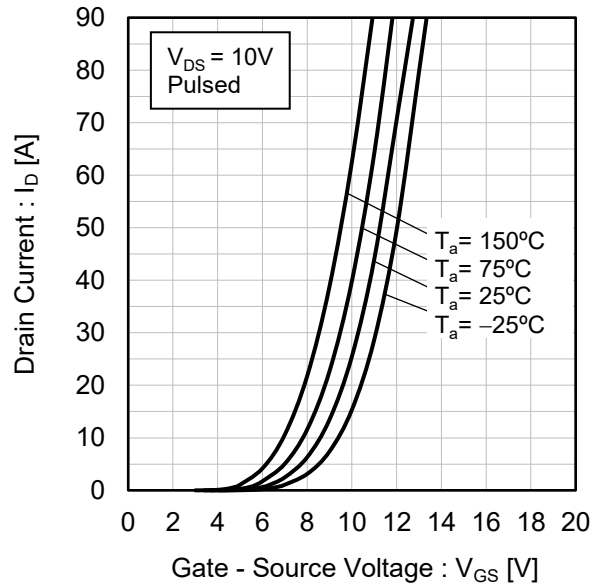


Fig.13 Gate Threshold Voltage vs. Junction Temperature

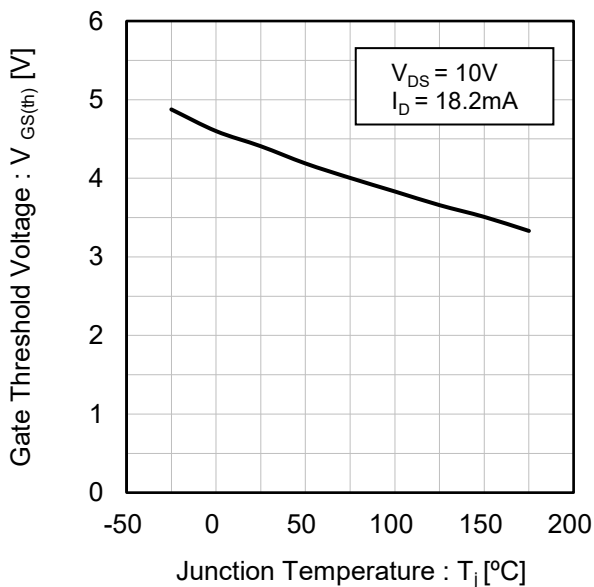
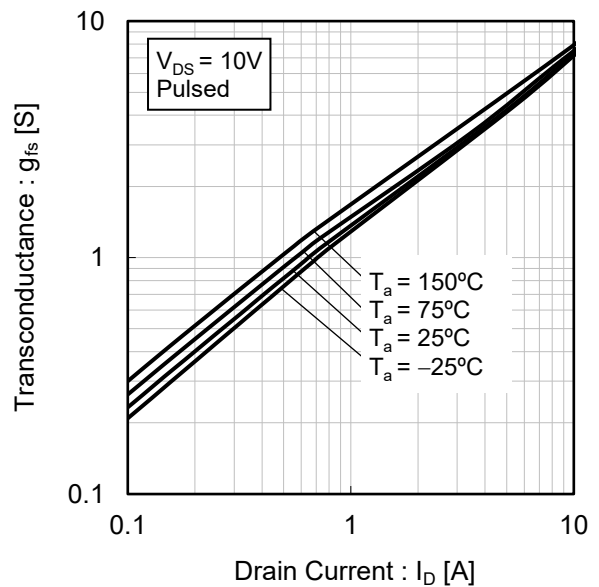


Fig.14 Transconductance vs. Drain Current





●Electrical characteristic curves

Fig.15 Static Drain - Source On - State Resistance vs. Gate - Source Voltage

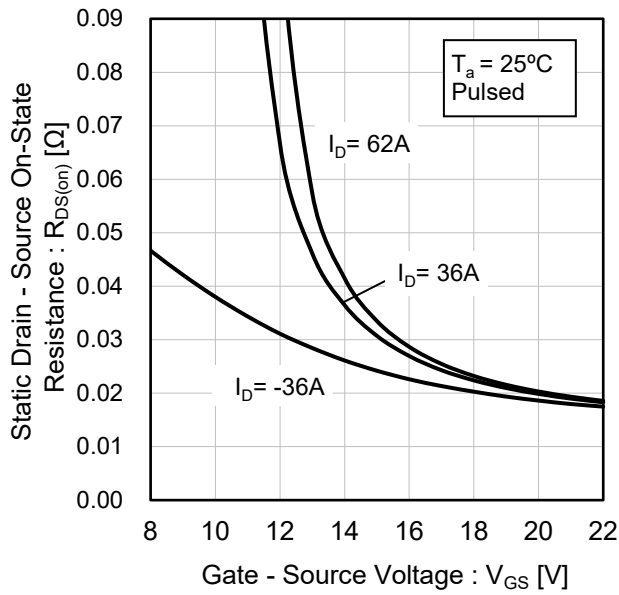


Fig.16 Static Drain - Source On - State Resistance vs. Junction Temperature

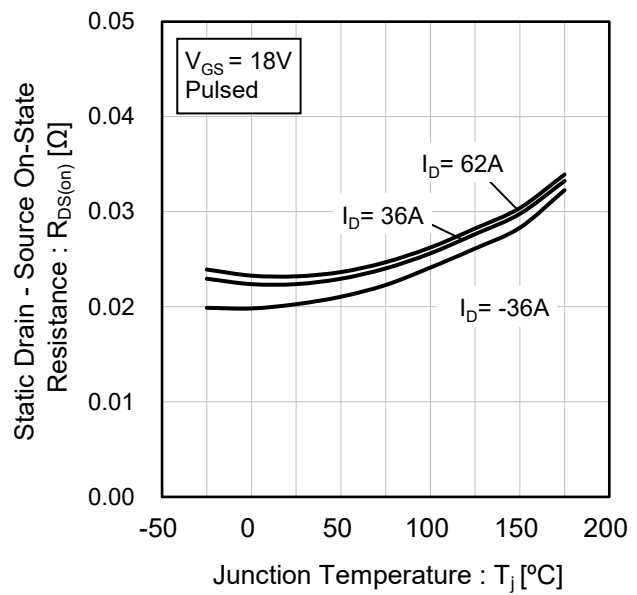


Fig.17 Static Drain - Source On - State Resistance vs. Drain Current

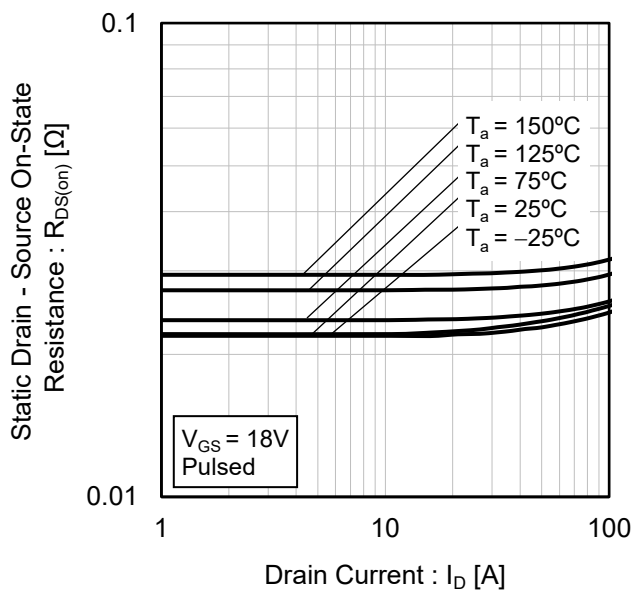
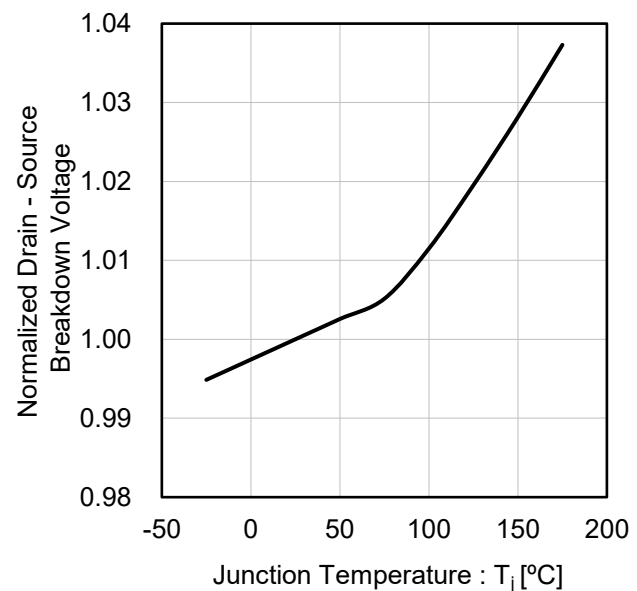


Fig.18 Normalized Drain - Source Breakdown Voltage vs. Junction Temperature



●Electrical characteristic curves

Fig.19 Typical Capacitance vs. Drain - Source Voltage

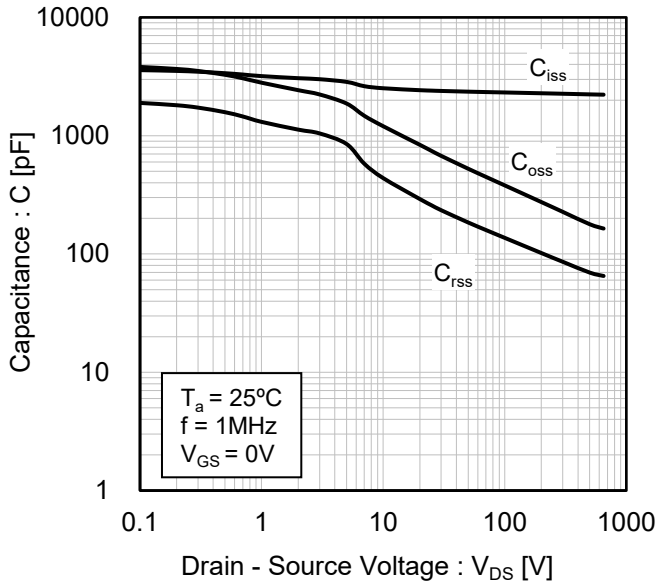


Fig.20  $C_{oss}$  Stored Energy

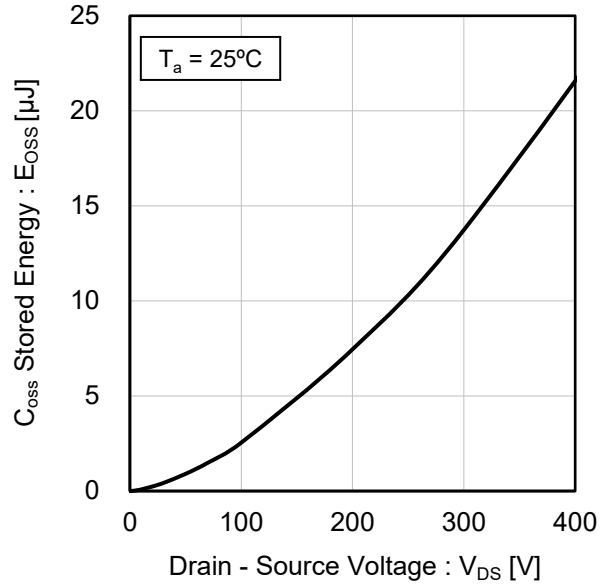
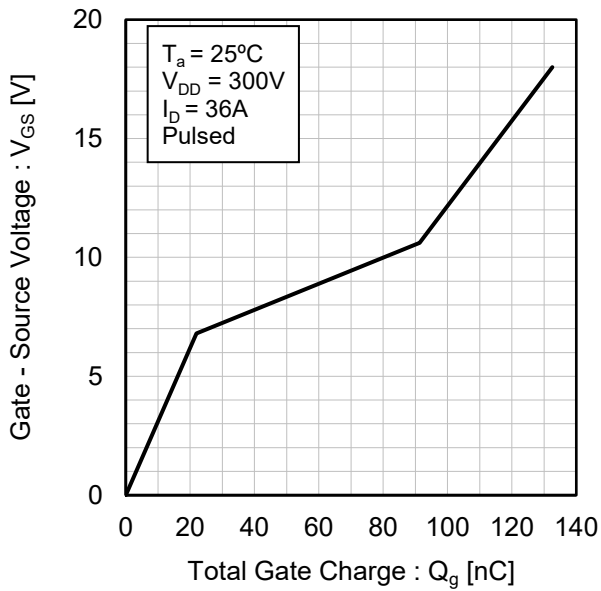
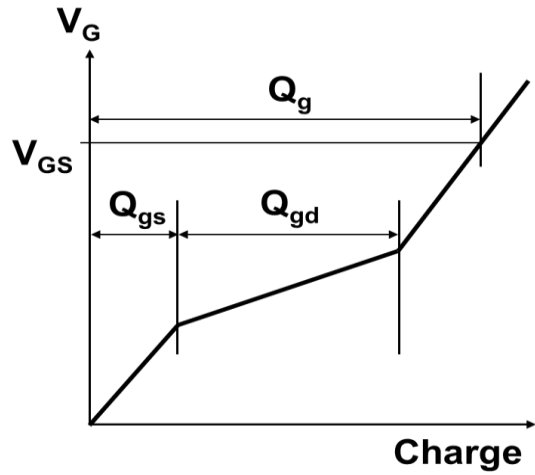


Fig.21 Dynamic Input Characteristics



\*Gate Charge Waveform



●Electrical characteristic curves

Fig.19 Typical Switching Time vs. Drain Current

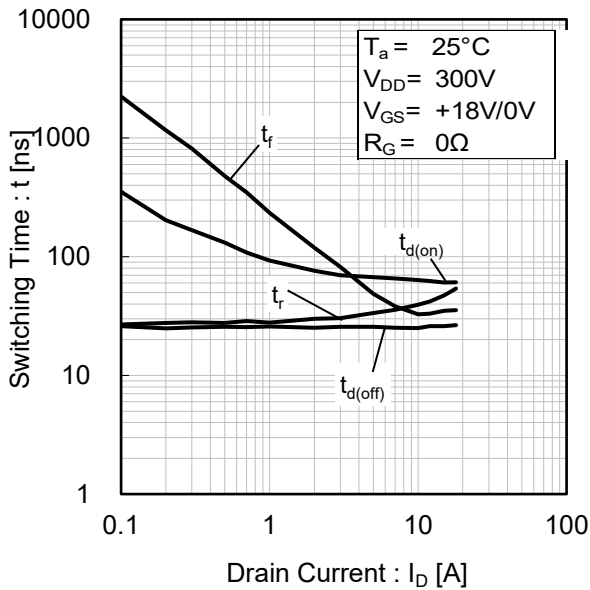


Fig.20 Typical Switching Loss vs. Drain - Source Voltage

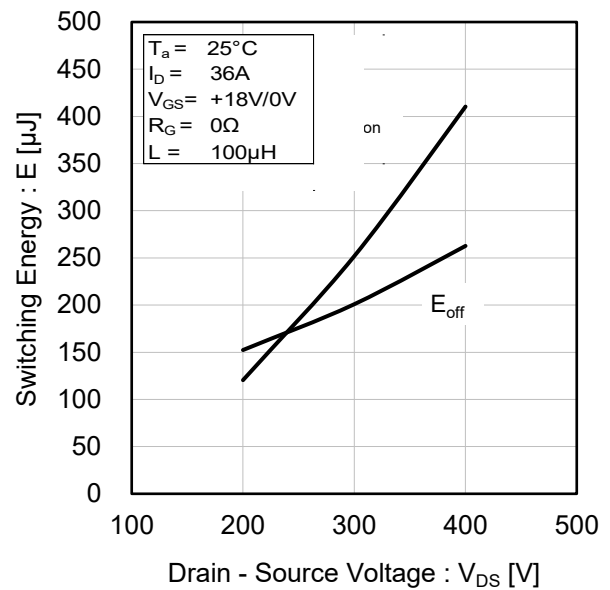


Fig.21 Typical Switching Loss vs. Drain Current

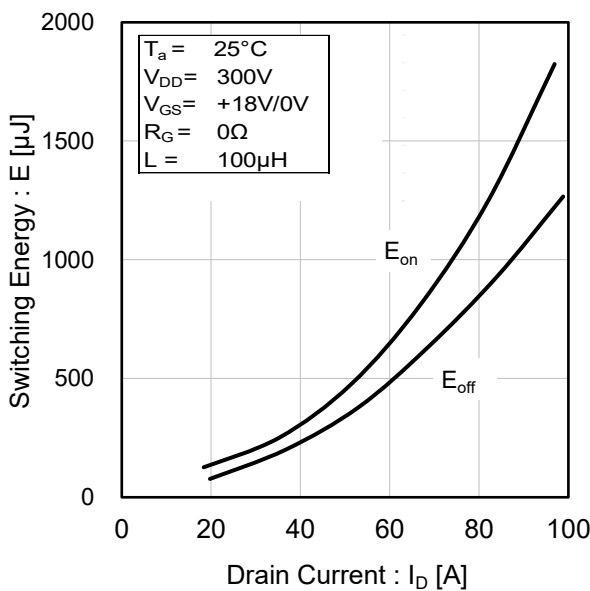
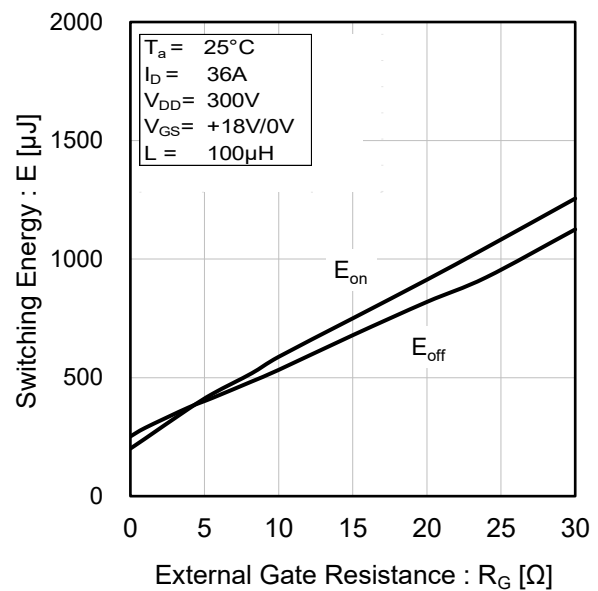


Fig.22 Typical Switching Loss vs. External Gate Resistance



● Measurement circuits and waveforms

Fig.1-1 Gate Charge and Switching Time Measurement Circuit

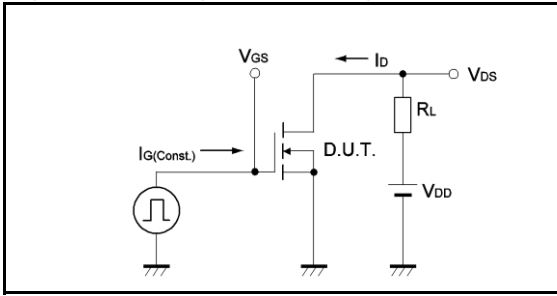


Fig.1-2 Waveforms for Switching Time

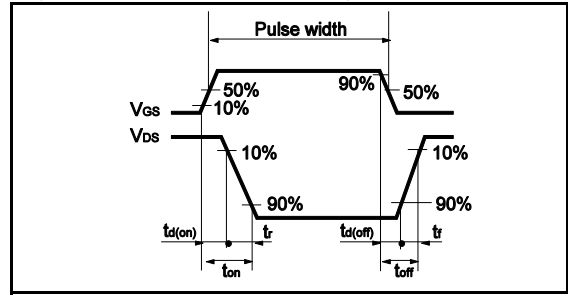


Fig.2-1 Switching Energy Measurement Circuit

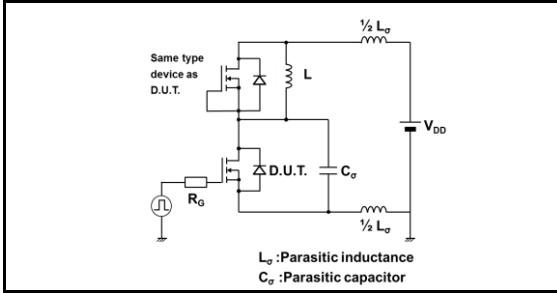


Fig.2-2 Waveforms for Switching Energy Loss

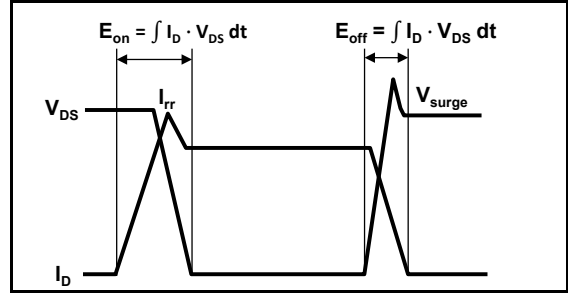


Fig.3-1 Reverse Recovery Time Measurement Circuit

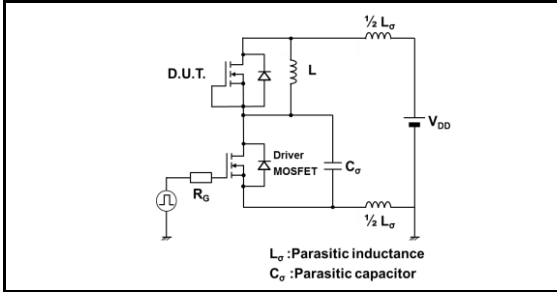
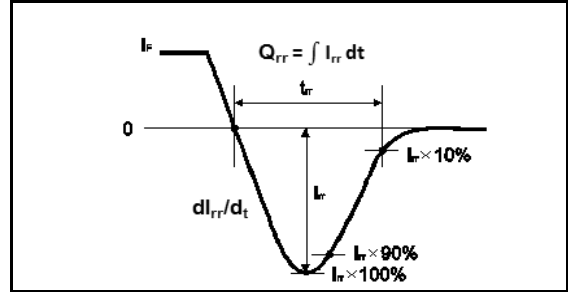


Fig.3-2 Reverse Recovery Waveform



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- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.